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PATENT APPLICATION

DOCKET NO. HA01-P01

**IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE**

RECEIVED
MAY 01 2003
TECHNOLOGY CENTER R3700

INVENTOR: Mark Rupert TUCKER

SERIAL NO.: 09/673,221

GROUP ART UNIT: 3721

FILING DATE: October 6, 2000

EXAMINER: NASH, Brian D.

TITLE: Method of Manufacturing Transdermal Patches

**ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231**

**RESPONSE TO OFFICE ACTION AND
REQUEST FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136(a)**

SIR OR MADAM:

This Response is to the Office action dated November 25, 2002.

Claim Summary:

Claims originally present: 1-19.
Claims previously canceled: none.
Claims previously amended: none.
Claims previously added: none.
Claims hereby canceled: 1 through 19.
Claims hereby amended: none.
Claims hereby being added: 20 through 39.
Claims remaining: 20-39(new).

04/11/2003 MDANTE1 00000014 09673221

01 FC:2251 55.00 OP

04/11/2003 MDANTE1 00000014 09673221

02 FC:1202 18.00 OP

S/N: 09/673,221
Amendment A